

Wallmount Box-Industrie-PC

Intel® Core™ i3 / i5 / i7 (3rd Generation / Ivy Bridge)

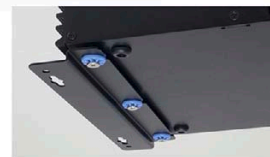
Lüfterlos



HM76
Intel® Chipset



- Fanless Core™ i
- 9–36 V_{DC} input
- viele Schnittstellen
- optional PCIe-x4 / PCI slot
- optional DVD-ROM
- gepufferte Montageschienen



PERFORMANCE

CPU (Intel® Mobile)	Core™ i3-3120M (2 x 2,5 GHz) Core™ i3-3120ME (2 x 2,4 GHz) Core™ i5-3610ME (2 x 2,7 GHz) Core™ i7-3610QE (4 x 2,3 GHz) (3 rd Generation / Ivy Bridge)
System memory	max. 2 x 8 GB DDR3 SO-DIMM
Power input	9–36 V _{DC}
Power supply	optional 24 V _{DC} external, 100–240 V _{AC}

SYSTEM

Chipset	Intel® HM76
Expansion slots	1 x Mini PCIe (internal) optional 1 x PCIe-x4 (10 W max., no DVD-ROM) optional 1 x PCI (no DVD-ROM)
Ethernet	2 x GbE: Intel® 82579LM / 82583V
Graphics	Intel® HD Graphics 4000 engine
Audio	Realtek® High Definition

DRIVES

Harddisk	min. 500 GB, 2,5" SATA or ...
Solid-state drive	min. 60 GB, 2,5" SATA min. 32 GB, CFast
CD/DVD ROM	optional slim type (no PCIe slot)

INTERFACES REAR

RS-232	COM1, COM3, COM4
RS-232/422/485	COM2
USB	4 x USB 3.0
RJ45 Ethernet	2
Graphic	VGA
Audio	line out / mic

INTERFACES FRONT

RS-232	COM5, COM6
USB	2 x USB 2.0
Digital I/O	8 in / 8 out 25-pin D-sub (or Phoenix)
Parallel port	25-pin D-sub
Graphic	2 x DisplayPort optional HDMI
CompactFlash	1 x CFast external (with cover)
SIM card slot	1 x external (with cover) for possible WWAN module

MECHANIK

Material	Aluminium (schwarz)
Maße (B x T x H)	260 x 200 x 89 mm
Montage	Montageschienen (gepuffert)
Kühlung	lüfterlos
Bedienelemente	Power On/Off, Kontroll-LEDs

QUALITÄT / TESTS

Burn-in Belastungstest	min. 24 Stunden
Produktion	ESD-geschützt
Qualitätsmanagement	nach ISO 9001:2008
Umweltmanagement	nach ISO 14001:2004
Betriebstemperatur	0–45° C
Gewährleistung	24 Monate
Dienstleistungspakete	Tests, Langlieferbarkeit, Installation, Anpassungen etc. nach Wunsch